NOTES:
1) DNI = DO NOT INSTALL
PLACE BYPASS CAPS PER SCHEMATIC ORDER.
100pF CLOSEST TO DEVICE PIN.

PLACE C61 AND C62 AT DEVICE PIN.
PLACE BYPASS CAPS PER SCHEMATIC ORDER.
100pF CLOSEST TO DEVICE PIN.

PLACE BYPASS CAPS PER SCHEMATIC ORDER.
100pF CLOSEST TO DEVICE PIN.
NOTE: FOR ADS4449 THE FOLLOWING PINS ARE NO CONNECT PINS: E3, G3, G4, G5.
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